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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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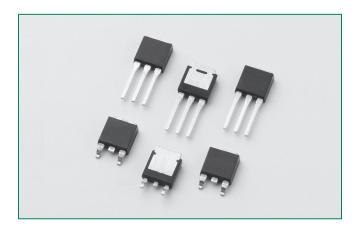








RoHS Sxx04xSx Series



Description

Excellent unidirectional switches for phase control applications such as heating and motor speed controls.

Sensitive gate SCRs are easily triggered with microAmps of current as furnished by sense coils, proximity switches, and microprocessors.

Features & Benefits

- RoHS compliant
- Glass passivated junctions
- Voltage capability up to 600 V
- Surge capability up to 30 A

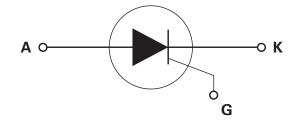
Main Features

Symbol	Value	Unit
I _{T(RMS)}	4	А
V _{DRM} /V _{RRM}	400 to 600	V
I _{GT}	50 to 500	μΑ

Applications

Typical applications are capacitive discharge systems for strobe lights, nailers, staplers and gas engine ignition. Also controls for power tools, home/brown goods and white goods appliances.

Schematic Symbol



Absolute Maximum Ratings

Symbol	Parameter	Test Conditions	Value	Unit
I _{T(RMS)}	RMS on-state current	T _C = 95°C	4	А
I _{T(AV)}	Average on-state current	$T_{c} = 75^{\circ}C$	2.5	А
1	Peak non-repetitive surge current	single half cycle; f = 50Hz; T _J (initial) = 25°C	25	А
I _{TSM}	Tour non repetitive surge current	single half cycle; f = 60Hz; T _J (initial) = 25°C	30	
l²t	l²t Value for fusing	t _p = 8.3 ms	3.7	A ² s
di/dt	Critical rate of rise of on-state current	f = 60Hz ; T _J = 110°C	50	A/µs
I _{GM}	Peak gate current	T _J = 110°C	1	А
P _{G(AV)}	Average gate power dissipation	T _J = 110°C	0.1	W
T _{stg}	Storage temperature range	-40 to 150	°C	
T _J	Operating junction temperature range		-40 to 110	°C

Teccor® brand Thyristors 4 Amp Sensitive SCRs



Electrical Characteristics — (T_J = 25°C, unless otherwise specified)

Cumahal	Test Conditions	Val	Value		
Symbol	lest Conditions		Sxx04xS1	Sxx04xS2	Unit
I _{GT}	V = 6V: P = 100 O	MAX.	50	200	μA
V _{GT}	$V_D = 6V; R_L = 100 \Omega$	MAX.	0.8		V
dv/dt	$V_{D} = V_{DRM}$, $R_{GK} = 1k\Omega$	TYP.	8		V/µs
V_{GD}	$V_D = V_{DRM}$; $R_L = 3.3 \text{ k}\Omega$; $T_J = 110$ °C	MIN.	0.2		V
V_{GD}	$I_{GR} = 10 \mu A$	MIN.	6	V	
I _H	$I_T = 20 \text{mA (initial)}; R_{GK} = 1 \text{kohm}$	MAX.	4	6	mA
t _q	(1)	MAX.	50)	μs
t _{gt}	$I_{G} = 2 \times I_{GT}$, PW = 15 μ s; $I_{T} = 8A$	TYP.	3	4	μs

Notes:

xx = voltage, x = package

(1) $I_{T}=2A$; $t_{n}=50\mu s$; $dv/dt=5V/\mu s$; $di/dt=-10A/\mu s$

Static Characteristics

Symbol		Value	Unit		
V _{TM}	Sxx04xSy I _T =	MAX.	1.6	V	
		T _J = 25°C	NAAV	2	
I _{DRM} / I _{RRM} V _{DRM} / V _{RRM} - K _{GK}	$V_{DRM}/V_{RRM} - R_{GK} = 1 \text{kohm}$	T _J = 110°C	MAX.	100	μΑ

Note : xx or z = voltage, x = package, y = sensitivity

Thermal Resistances

Symbol	Parameter	Value	Unit	
D	Junction to case (AC)	Sxx04VSy	3.8	°C/W
$R_{\theta(J-C)}$ Junction t	Junction to case (AC)	Sxx04DSy	3.0	C/VV
$R_{\theta(J-A)}$	Junction to ambient	Sxx04VSy	85	°C/W

Notes: xx = voltage, y = sensitivity



Figure 1: Normalized DC Gate Trigger Current vs. Junction Temperature

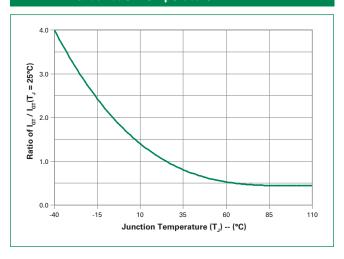


Figure 2: Normalized DC Gate Trigger Voltage vs. Junction Temperature

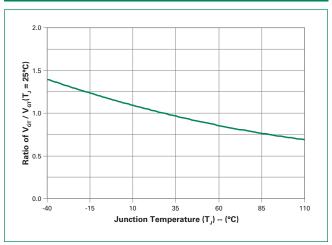


Figure 3: Normalized DC Holding Current vs. Junction Temperature

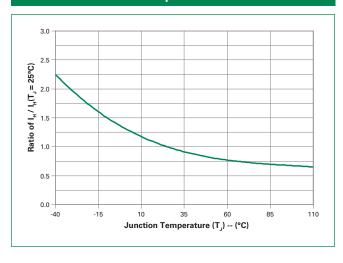


Figure 4: Normalized DC Latching Current vs. Junction Temperature

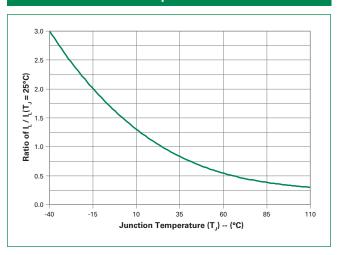


Figure 5: On-State Current vs. On-State Voltage (Typical)

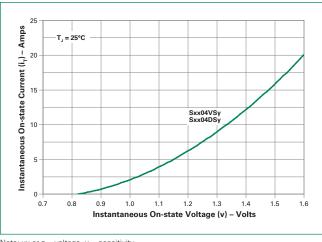
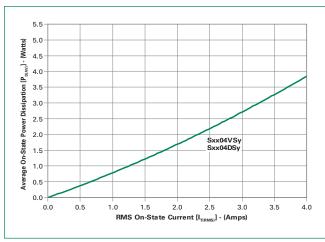


Figure 6: Power Dissipation (Typical) vs. RMS On-State Current



Note: xx or z = voltage, y = sensitivity



Figure 7: Maximum Allowable Case Temperature vs. RMS On-State Current

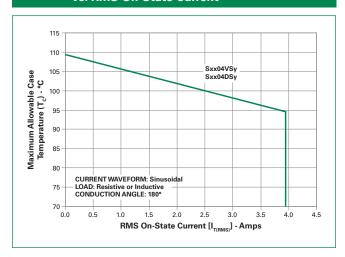


Figure 8: Maximum Allowable Case Temperature vs. Average On-State Current

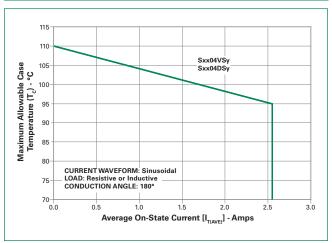


Figure 9: Maximum Allowable Ambient Temperature
vs. RMS On-State Current

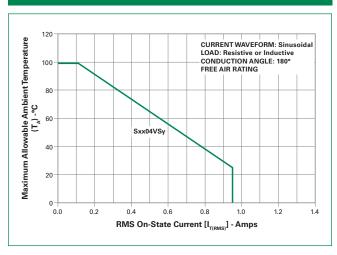


Figure 10: Maximum Allowable Ambient Temperature vs. Average On-State Current

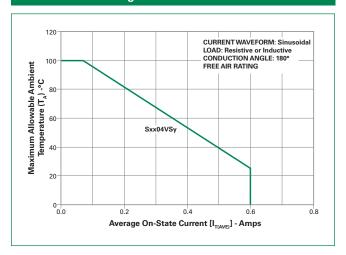


Figure 11: Peak Repetitive Capacitor Discharge Current

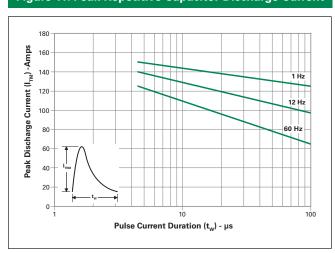
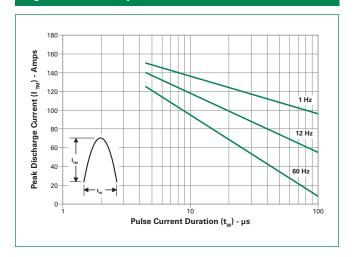


Figure 12: Peak Repetitive Sinusoidal Pulse Current



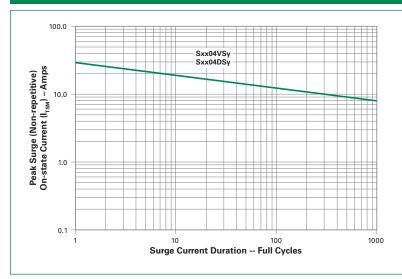
Note: xx = voltage, y = sensitivity

Please refer to http://www.littelfuse.com for current information.

Sxx04xSx Series



Figure 13: Surge Peak On-State Current vs. Number of Cycles



SUPPLY FREQUENCY: 60 Hz Sinusoidal

LOAD: Resistive

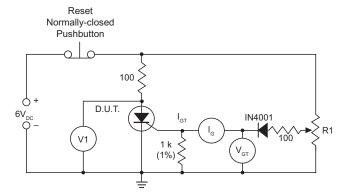
RMS On-State Current: $[I_{T(RMS)}]$: Maximum Rated Value at Specified Case Temperature

Notes:

- 1. Gate control may be lost during and immediately following surge current interval.
- 2. Overload may not be repeated until junction temperature has returned to steady-state rated value.

Note: xx or z - voltage, y = sensitivity

Figure 14: Simple Test Circuit for Gate Trigger Voltage and Current



Note: V1 — 0 V to 10 V dc meter V_{GT} — 0 V to 1 V dc meter I_G — 0 mA to 1 mA dc milliammeter R1 — 1 k potentiometer

To measure gate trigger voltage and current, raise gate voltage (V_{ct}) until meter reading V1 drops from 6 V to 1 V. Gate trigger voltage is the reading on $V_{\rm GT}$ just prior to V1 dropping. Gate trigger current $I_{\rm GT}$ Can be computed from the relationship

$$I_{\rm GT} = I_{\rm G} - \frac{V_{\rm GT}}{1000} \text{Amps}$$

where I_c is reading (in amperes) on meter just prior to V1 dropping

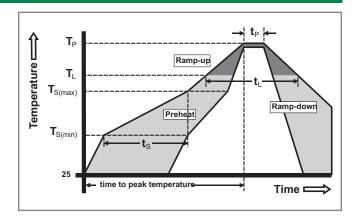
Note: I_{GT} may turn out to be a negative quantity (trigger current flows out from gate lead). If negative current occurs, I_{GT} value is not a valid reading. Remove 1 k resistor and use $l_{\rm g}$ as the more correct $l_{\rm gr}$ value. This will occur on 12 µA gate products.

Teccor® brand Thyristors 4 Amp Sensitive SCRs



Soldering Parameters

Reflow Co	ndition	Pb – Free assembly
	-Temperature Min (T _{s(min)})	150°C
Pre Heat	-Temperature Max (T _{s(max)})	200°C
	-Time (min to max) (t _s)	60 - 180 secs
Average ra	amp up rate (Liquidus Temp) k	5°C/second max
T _{S(max)} to T _L	- Ramp-up Rate	5°C/second max
Reflow	-Temperature (T _L) (Liquidus)	217°C
nellow	-Temperature (t _L)	60 – 150 seconds
PeakTemp	erature (T _P)	260+ ^{0/-5} °C
Time with	in 5°C of actual peak ıre (t _p)	20 - 40 seconds
Ramp-dov	vn Rate	5°C/second max
Time 25°C	to peakTemperature (T _P)	8 minutes Max.
Do not exc	ceed	280°C



Physical Specifications

Terminal Finish	100% Matte Tin-plated
Body Material	UL recognized epoxy meeting flammability classification 94V-0
Lead Material	Copper Alloy

Design Considerations

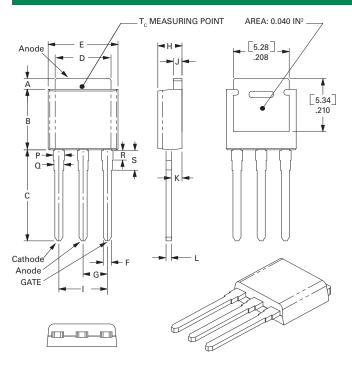
Careful selection of the correct device for the application's operating parameters and environment will go a long way toward extending the operating life of the Thyristor. Good design practice should limit the maximum continuous current through the main terminals to 75% of the device rating. Other ways to ensure long life for a power discrete semiconductor are proper heat sinking and selection of voltage ratings for worst case conditions. Overheating, overvoltage (including dv/dt), and surge currents are the main killers of semiconductors. Correct mounting, soldering, and forming of the leads also help protect against component damage.

Environmental Specifications

Test	Specifications and Conditions
AC Blocking	MIL-STD-750, M-1040, Cond A Applied Peak AC voltage @ 125°C for 1008 hours , R _{GK} = 1kohms
Temperature Cycling	MIL-STD-750, M-1051, 100 cycles; -40°C to +150°C; 15-min dwell-time
Temperature/ Humidity	EIA / JEDEC, JESD22-A101 1008 hours; 320V - DC: 85°C; 85% rel humidity
High Temp Storage	MIL-STD-750, M-1031, 1008 hours; 150°C
Low-Temp Storage	1008 hours; -40°C
Thermal Shock	MIL-STD-750, M-1056 10 cycles; 0°C to 100°C; 5-min dwelltime at each temperature; 10 sec (max) transfer time between temperature
Autoclave	EIA / JEDEC, JESD22-A102 168 hours (121°C at 2 ATMs) and 100% R/H
Resistance to Solder Heat	MIL-STD-750 Method 2031
Solderability	ANSI/J-STD-002, category 3, Test A
Lead Bend	MIL-STD-750, M-2036 Cond E

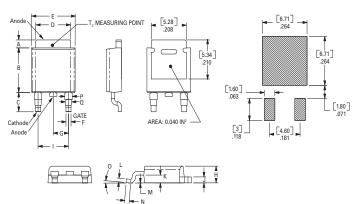


Dimensions — TO-251AA (V/I-Package) — V/I-PAK Through Hole



Dimension		Inches		Millimeters		
Dimension	Min	Тур	Max	Min	Тур	Max
А	0.040	0.044	0.050	1.02	1.11	1.27
В	0.235	0.242	0.245	5.97	6.15	6.22
С	0.350	0.361	0.375	8.89	9.18	9.53
D	0.205	0.208	0.213	5.21	5.29	5.41
Е	0.255	0.262	0.265	6.48	6.66	6.73
F	0.027	0.031	0.033	0.69	0.80	0.84
G	0.087	0.090	0.093	2.21	2.28	2.36
Н	0.085	0.092	0.095	2.16	2.34	2.41
I	0.176	0.180	0.184	4.47	4.57	4.67
J	0.018	0.020	0.023	0.46	0.51	0.58
K	0.038	0.040	0.044	0.97	1.01	1.12
L	0.018	0.020	0.023	0.46	0.52	0.58
Р	0.042	0.047	0.052	1.06	1.20	1.32
Q	0.034	0.039	0.044	0.86	1.00	1.11
R	0.034	0.039	0.044	0.86	1.00	1.11
S	0.074	0.079	0.084	1.86	2.00	2.11

Dimensions — TO-252AA (D-Package) — D-PAK Surface Mount



Dimension	Inches			Millimeters		
Dilliension	Min	Тур	Max	Min	Тур	Max
А	0.040	0.043	0.050	1.02	1.09	1.27
В	0.235	0.243	0.245	5.97	6.16	6.22
С	0.106	0.108	0.113	2.69	2.74	2.87
D	0.205	0.208	0.213	5.21	5.29	5.41
Е	0.255	0.262	0.265	6.48	6.65	6.73
F	0.027	0.031	0.033	0.69	0.80	0.84
G	0.087	0.090	0.093	2.21	2.28	2.36
Н	0.085	0.092	0.095	2.16	2.33	2.41
1	0.176	0.179	0.184	4.47	4.55	4.67
J	0.018	0.020	0.023	0.46	0.51	0.58
K	0.038	0.040	0.044	0.97	1.02	1.12
L	0.018	0.020	0.023	0.46	0.51	0.58
М	0.000	0.000	0.004	0.00	0.00	0.10
N	0.021	0.026	0.027	0.53	0.67	0.69
0	0°	0°	5°	0°	0°	5°
Р	0.042	0.047	0.052	1.06	1.20	1.32
Q	0.034	0.039	0.044	0.86	1.00	1.11

Teccor® brand Thyristors 4 Amp Sensitive SCRs



Product Selector

Part Number	Voltage				Coto Consistivista	Time	Doolsomo
rait ivuilibei	400V	600V	800V	1000V	Gate Sensitivity	Туре	Package
Sxx04DS1	X	X			50μΑ	Sensitive SCR	TO-252
Sxx04DS2	X	X			200μΑ	Sensitive SCR	TO-252
Sxx04VS1	X	X			50μΑ	Sensitive SCR	TO-251
Sxx04VS2	Х	Х			200μΑ	Sensitive SCR	TO-251

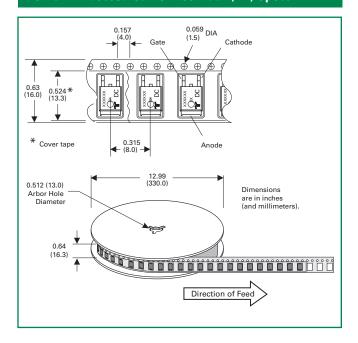
Note: xx = Voltage

Packing Options

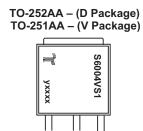
Part Number	Marking	Weight	Packing Mode	Base Quantity
Sxx04DSyTP	Sxx04DSy	0.3g	Tube	750 (75 per tube)
Sxx04DSyRP	Sxx04DSy	0.3g	Embossed Carrier	2500
Sxx04VSyTP	Sxx04VSy	0.4g	Tube	750 (75 per tube)

Note: xx = voltage, y = sensitivity

TO-252 Embossed Carrier Reel Pack (RP) Specs



Part Marking System



Part Numbering System

